

Electronic Materials and Devices

2 Classical electrical and thermal conductance in solids

QQ Group:

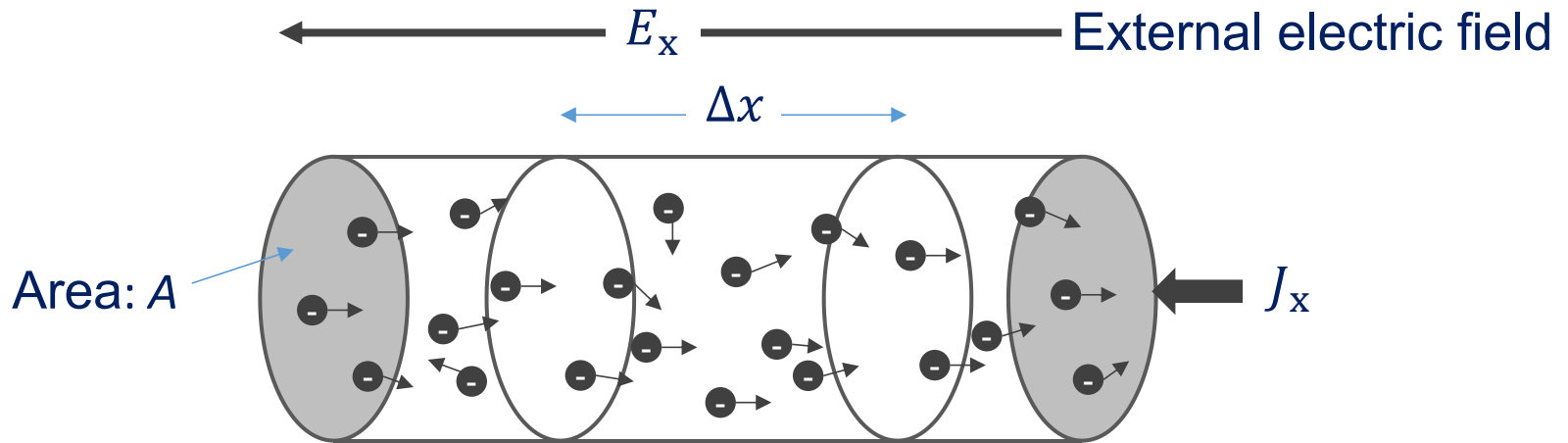


群名称:电子功能材料与器件
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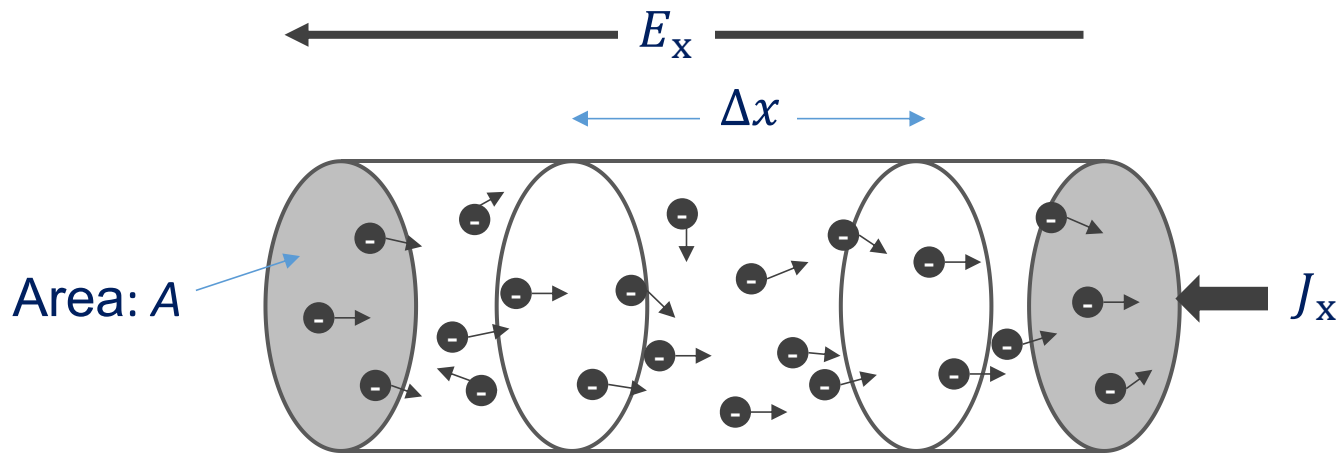
电子与电气工程系

2.1 Classic theory: the Drude model



The **electric current density J** is defined as the net amount of charge flowing across a unit area per unit time:

$$J_x = \frac{\Delta q}{A \Delta t}$$



Carrier density n : the number of conduction electrons per unit volume.

Drift velocity v_{dx} : the average velocity of the electrons in x-direction.

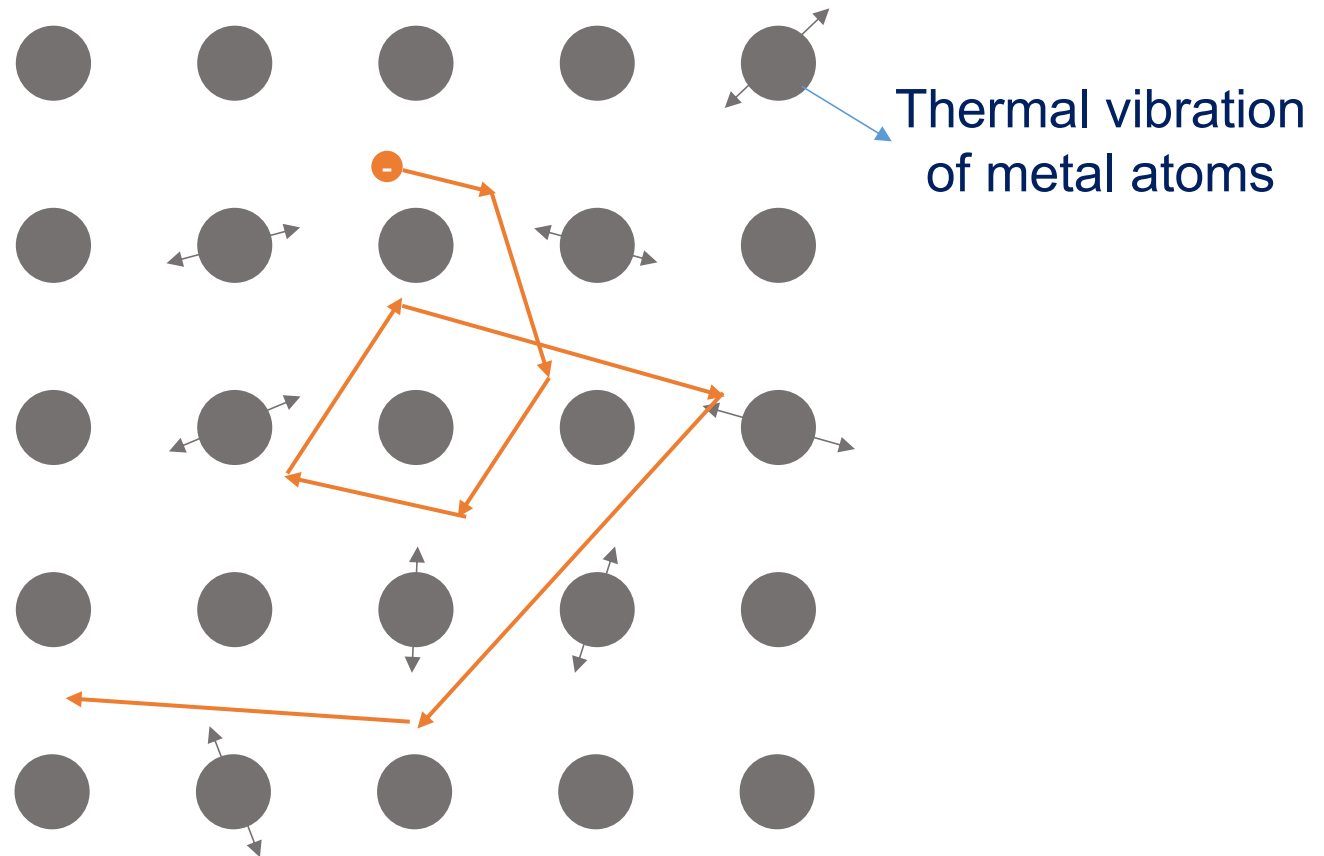
漂移速度

$$v_{dx} = \frac{1}{N} \sum_{i=1}^N v_{xi}$$

Electric current density :
$$J_x = \frac{\Delta q}{A \Delta t} = \frac{enAv_{dx}\Delta t}{A \Delta t} = env_{dx}$$

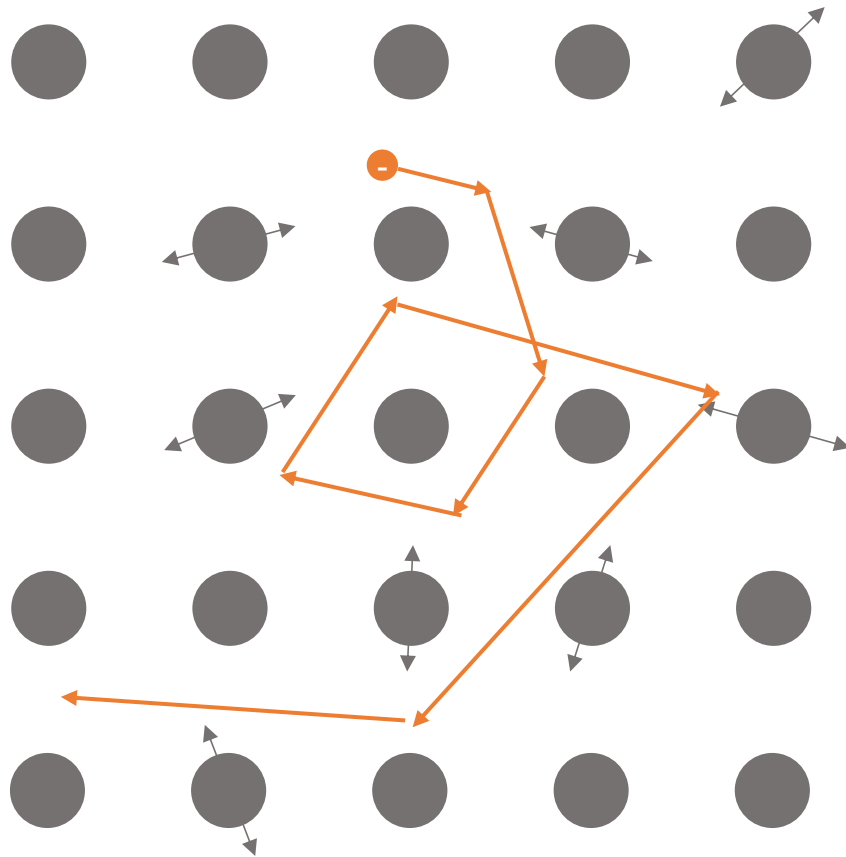
Question: Drift velocity v_{dx} vs mean speed of electron?

When there is no external electric field:



A conduction electron i^{th} in the electron gas moves about randomly in a metal with a mean speed u .

When there is no external electric field:

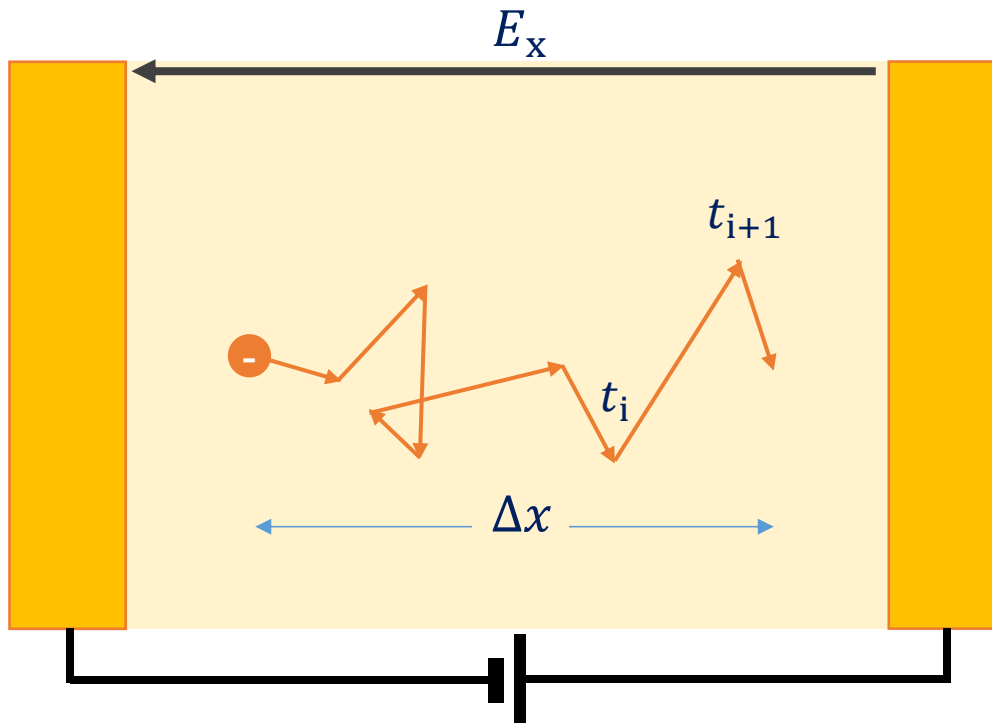


At time t , the average drift velocity in x-direction of all electrons $\frac{1}{N} \sum_{i=1}^N u_{xi}$?

$$\frac{1}{N} \sum_{i=1}^N u_{xi} = 0$$

No net current flow!

Apply an external electric field:



For the i^{th} electron, suppose its last collision was at time t_i , the velocity in x-direction at time t :

$$v_{xi} = u_{xi} + \frac{eE_x}{m_e}(t - t_i), \quad t_i < t < t_{i+1}$$

The average drift velocity:

$$v_{dx} = \frac{1}{N} \sum_{i=1}^N v_{xi} = \frac{1}{N} \sum_{i=1}^N u_{xi} + \frac{eE_x}{m_e} \frac{1}{N} \sum_{i=1}^N (t - t_i) = \frac{eE_x}{m_e} \overline{(t - t_i)}$$

$\overline{(t - t_i)}$ is the average free time for N electrons between collisions.

$\tau = \overline{(t - t_i)}$: **mean time between collisions/ mean scattering time**
平均散射时间/ mean free time/ relaxation time弛豫时间.

$$v_{dx} = \frac{e\tau}{m_e} E_x$$

We introduce the electron **drift mobility** 迁移率: $\mu_d = \frac{e\tau}{m_e}$. $\text{m}^2 / (\text{V s})$

$$v_{dx} = \mu_d E_x$$

The current density: $J_x = en v_{dx} = en \mu_d E_x$

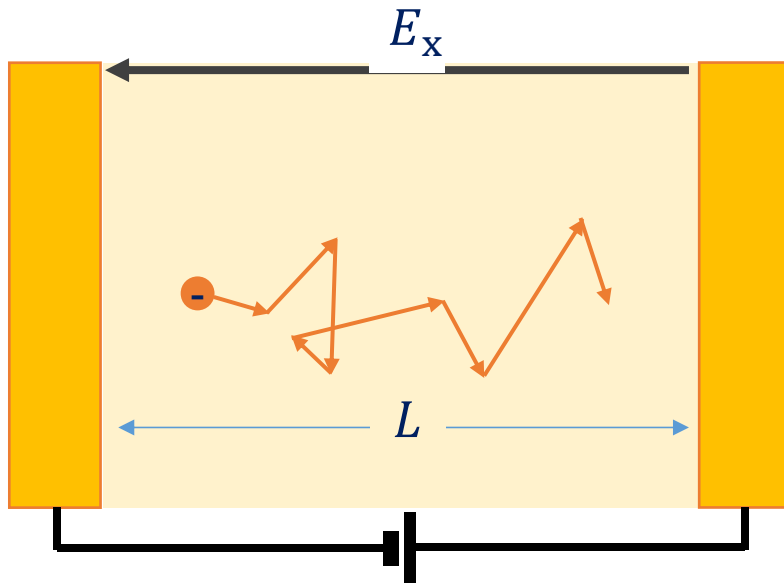
The **conductivity** is defined as $\sigma = \frac{J_x}{E_x}$.

$$\sigma = en \mu_d$$

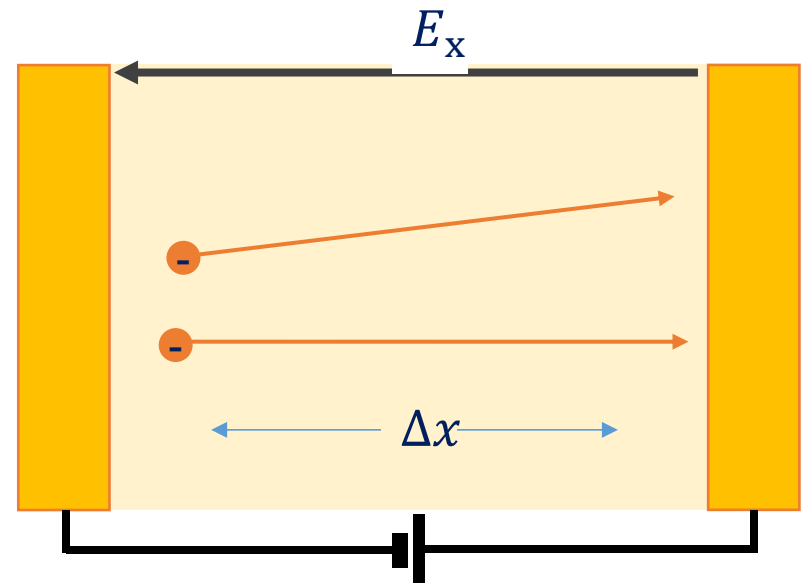
This is Drude model!

Q: What's the condition for this formula?

The condition for the formula $\sigma = en\mu_d$

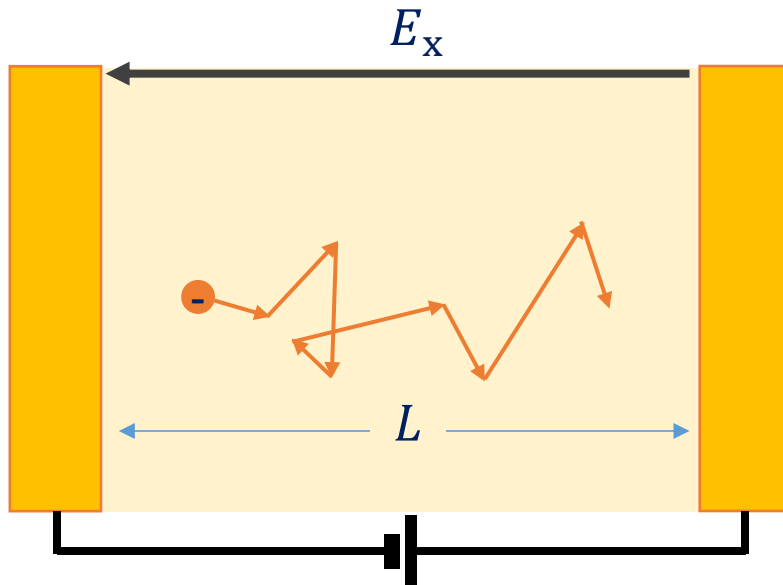


Diffusive transport



Ballistic transport





Diffusive transport

Mean free path 平均自由程:

$$l = u\tau$$

Mean velocity
(not drift velocity)

Mean free time

$$\sigma = en\mu_d \text{ is true when } l < L$$



Paul Karl Ludwig Drude

July 12, 1863 - July 5, 1906

- ◆ Drude began his studies in **mathematics** at the University of Gottingen, but later changed his major to **physics**.
- ◆ Thus Drude began his professional career at the time **Maxwell's theories** were being introduced into Germany
- ◆ His first experiments were the determination of the **optical constants of various solids**. He then worked to derive relationships between the optical and electrical constants. In 1894 he was responsible for introducing the **symbol "c"** for the speed of light in a perfect vacuum.
- ◆ In 1905 he became the director of the physics institute of the **University of Berlin**. In 1906, at the height of his career, he became a member of the **Prussian Academy of Sciences**. A few days after his inauguration lecture, for inexplicable reasons, he committed **suicide**.

2.2 Temperature dependence of resistivity: ideal pure metals

Ideal pure metals: the conduction electrons are only scattered by thermal vibrations of the metal ions

Question: $\sigma \sim T$?

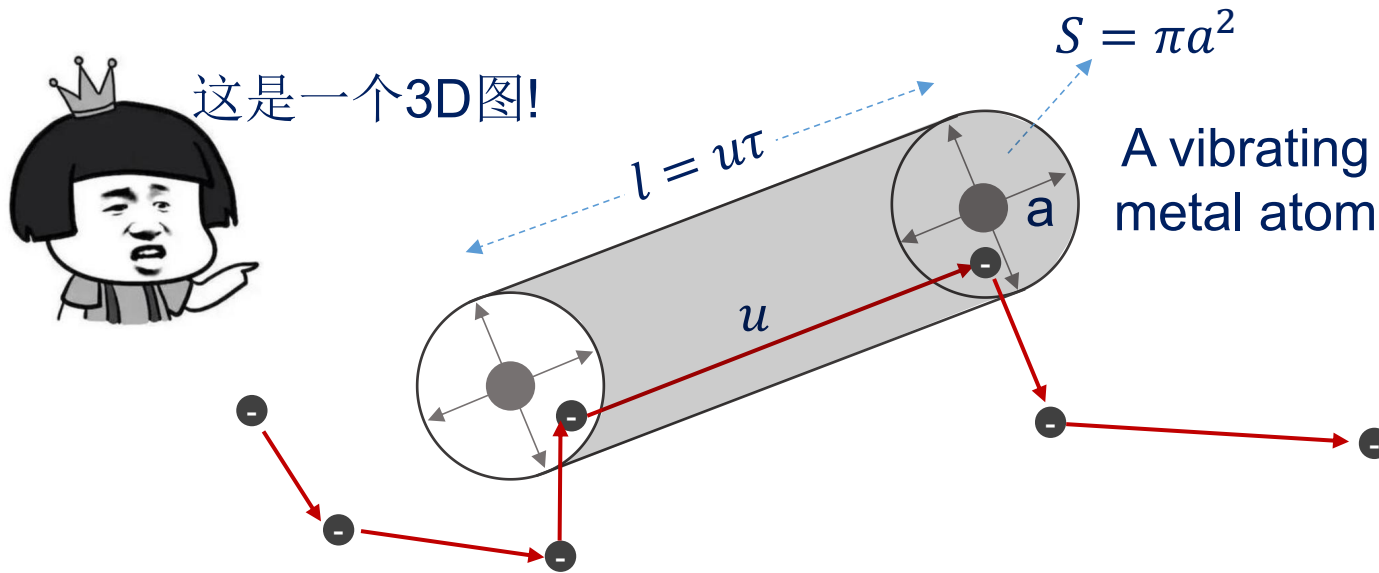
◆ Let's start from the Drude model

$$\sigma = en\mu_d \quad \mu_d = \frac{e\tau}{m_e}$$

τ : the mean free time due to thermal vibration scattering

◆ Only τ strongly depends on temperature

A simple classic model



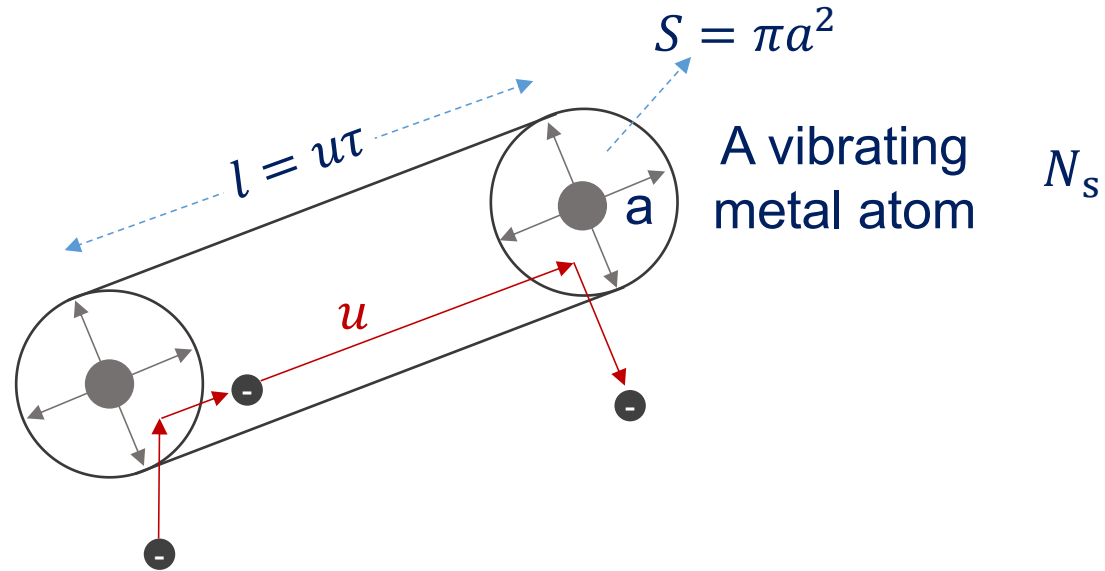
Scattering cross-sectional area: $S = \pi a^2$

Mean free path: $l = u\tau$

The concentration of scattering centers: N_s

Q: What's the relation between S , τ , and N_s ?

A simple classic model



There is 1 scattering event in the volume $SlN_s = 1$

$$\Rightarrow \tau = \frac{1}{SuN_s} = \frac{1}{\pi a^2 u N_s}$$

Assume the mean speed u is constant.

$$\tau = \frac{1}{\pi a^2 u N_s}$$

Q: The vibration amplitude a ?

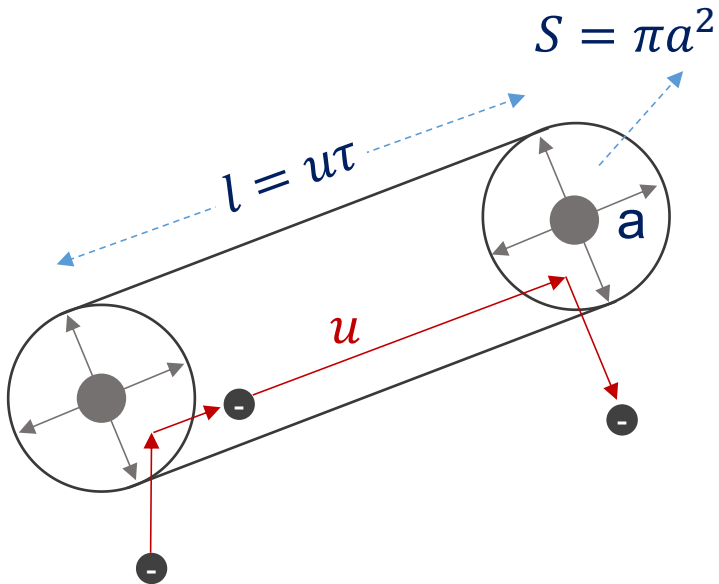
The vibration energy \approx thermal energy

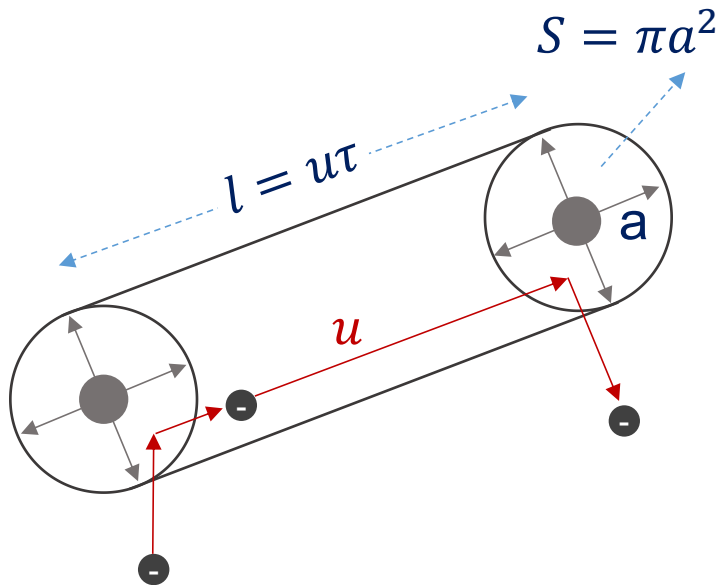
$$\frac{1}{4} M a^2 \omega^2 \approx \frac{1}{2} k T$$



$$\tau \propto \frac{1}{\pi a^2} \propto \frac{1}{T} \quad \text{or} \quad \tau = \frac{C}{T}$$

C is a temperature-independent constant.





Mobility: $\mu_d = \frac{e\mathcal{C}}{m_e T}$

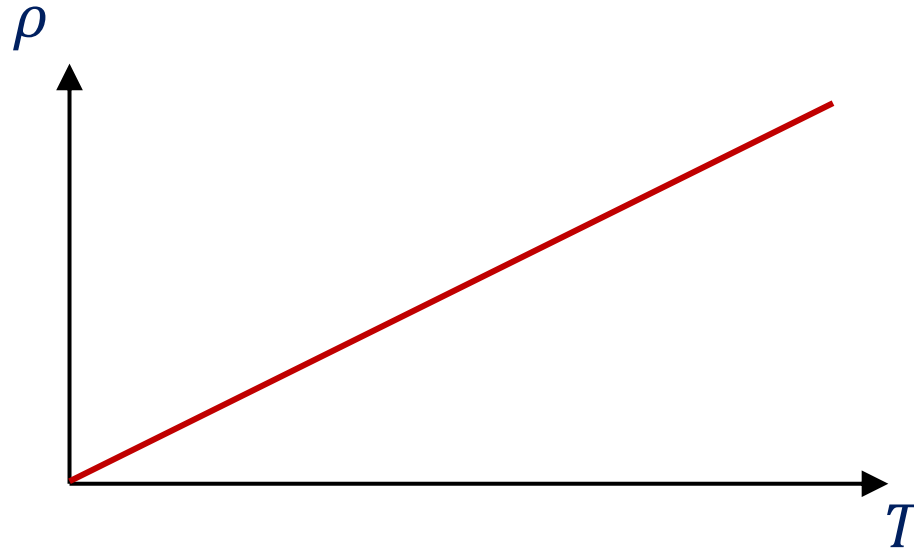
Lattice-scattering-limited
conductivity and resistivity:

$$\rho_T = \frac{1}{\sigma_T} = \frac{1}{en\mu_d}$$

$$= \frac{m_e T}{e^2 n \mathcal{C}}$$

Lattice-scattering-limited resistivity:

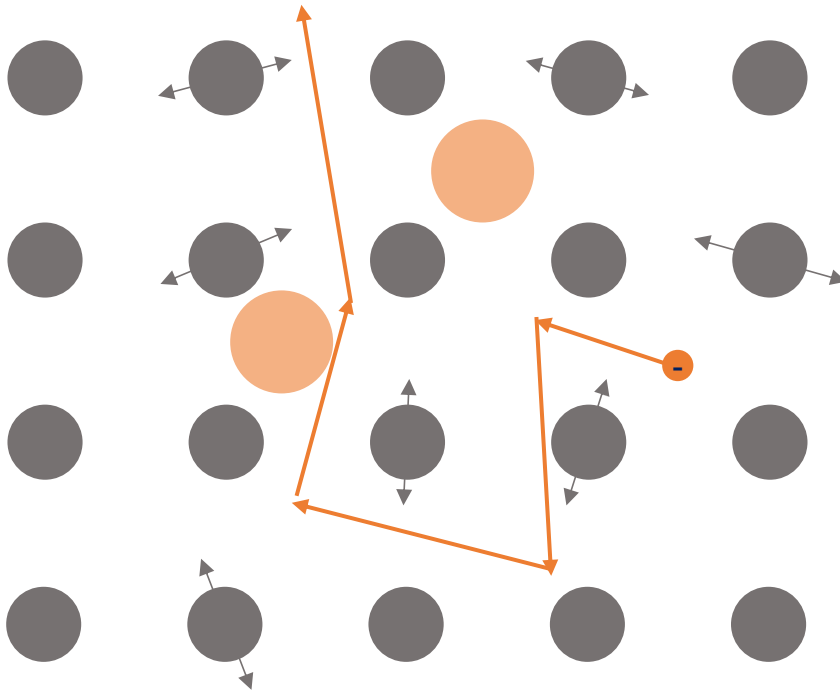
$$\rho_T = \frac{m_e T}{e^2 n C}$$



2.3 Temperature dependence of resistivity: including impurity scattering



In real case, there must be impurities in metals.



Electrons also suffer the scatterings from impurities.

We define:

τ_T : mean free time from thermal scatterings/lattice vibrations

τ_I : mean free time from impurity scatterings

$\left\{ \begin{array}{l} \frac{1}{\tau_T}: \text{probability of scattering from lattice vibration} \\ \frac{1}{\tau_I}: \text{probability of scattering from impurities} \\ \frac{1}{\tau}: \text{the net probability of scattering} \end{array} \right.$

$$\frac{1}{\tau} = \frac{1}{\tau_T} + \frac{1}{\tau_I}$$

Mobility: $\mu_d = \frac{e\tau}{m_e}$

{	$\mu_d = \frac{e\tau}{m_e}$	Drift velocity of the system
	$\mu_T = \frac{e\tau_T}{m_e}$	Lattice-scattering-limited drift velocity
	$\mu_I = \frac{e\tau_I}{m_e}$	Impurity-scattering-limited drift velocity

$$\frac{1}{\mu_d} = \frac{1}{\mu_T} + \frac{1}{\mu_I}$$

Resistivity: $\rho = \frac{1}{en\mu_d}$

{	$\rho = \frac{1}{en\mu_d}$	Resistivity of the system
	$\rho_T = \frac{1}{en\mu_L}$	Resistivity due to lattice vibration scatterings
	$\rho_I = \frac{1}{en\mu_I}$	Resistivity due to impurity scatterings

Matthiessen's rule

$$\rho = \rho_T + \rho_I$$

Matthiessen's rule: $\rho = \rho_T + \underline{\rho_R}$



Can be electrons scattering from dislocations and other crystal defects, as well as from grain boundaries. Hence ρ_R includes ρ_I .

ρ_R : very small temperature dependence

$$\rho = AT + B$$

A and B are temperature-independent constants.

The temperature coefficient of resistivity (TCR) α_0

$$\alpha_0 = \frac{1}{\rho_0} \left[\frac{\delta \rho}{\delta T} \right]_{T=T_0}$$

ρ_0 : the resistivity at the reference temperature T_0 , usually 273 K or 293 K.

Q: When resistivity follows $\rho = AT + B$, what's the relation between ρ and α_0 ?

Q: When resistivity follows $\rho = AT + B$, what's the relation between ρ and α_0 ?

$$\left\{ \begin{array}{l} \alpha_0 = \frac{1}{\rho_0} \left[\frac{\delta \rho}{\delta T} \right]_{T=T_0} = \frac{A}{\rho_0} \\ \rho_0 = AT_0 + B \end{array} \right.$$



$$\left\{ \begin{array}{l} A = \alpha_0 \rho_0 \\ B = \rho_0 - \alpha_0 \rho_0 T_0 \end{array} \right.$$



$$\rho = \rho_0 [1 + \alpha_0 (T - T_0)]$$

Q: For pure metals, what's the relation between ρ and α_0 ?

When $T = 0$, $\rho = 0$.



$$0 = \rho_0[1 + \alpha_0(0 - T_0)]$$



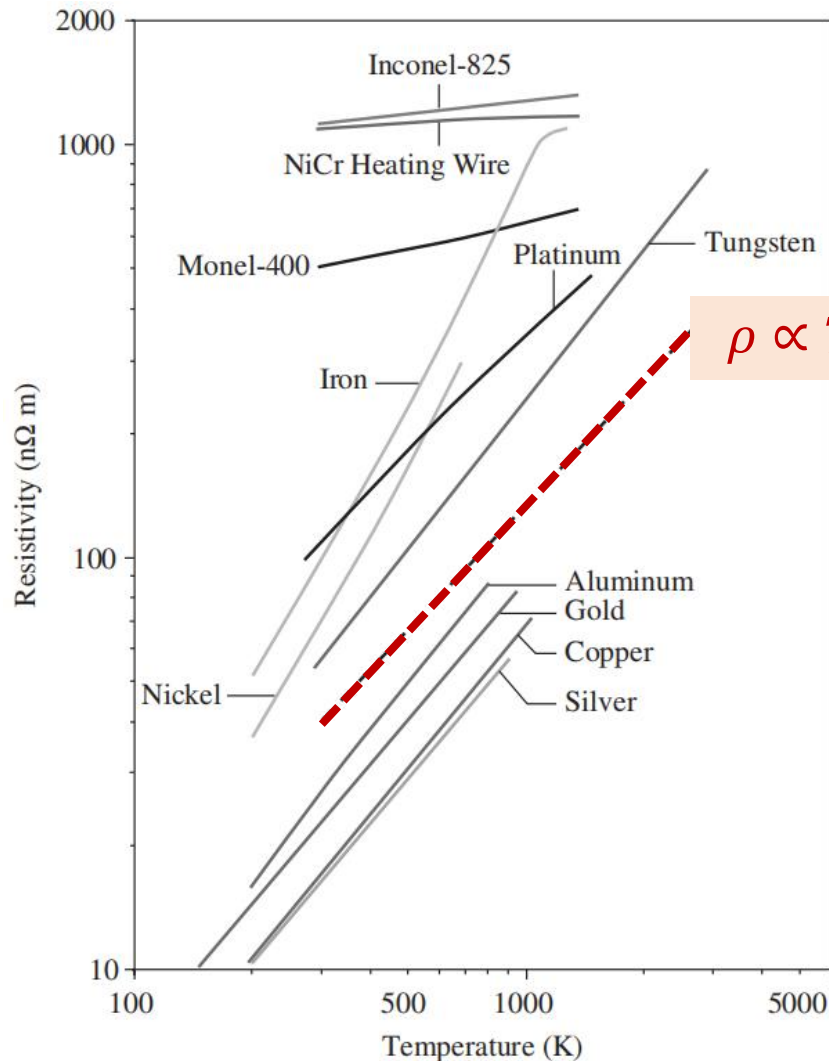
$$\alpha_0 = 1/T_0$$



$$\rho = \rho_0 \frac{T}{T_0}$$

If the reference temperature $T_0 = 273 \text{ K}$, $\alpha_0 = \frac{1}{273} \text{ K}^{-1}$.

In real conditions, only **some metals** follow this relation in **certain temperature range!**



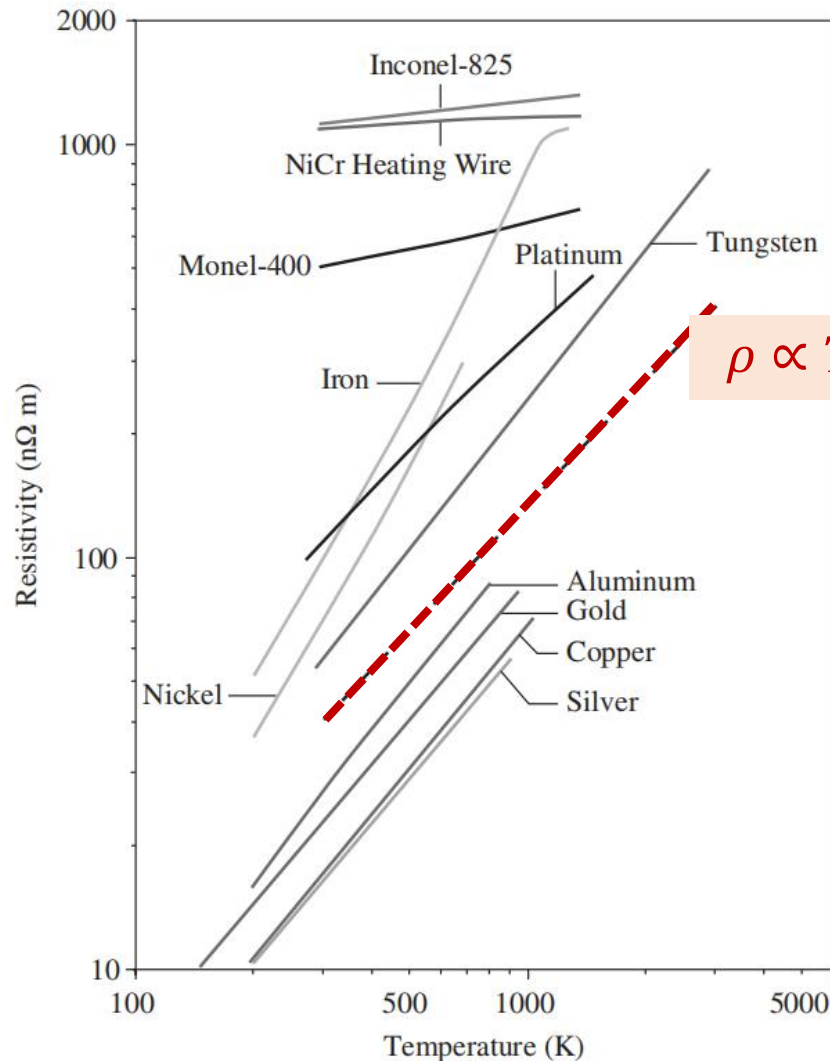
Aluminum, gold, copper, silver follows the $\rho = \rho_0 \frac{T}{T_0}$ quite well.

Magnetic metals such as iron, nickel deviate from $\rho = \rho_0 \frac{T}{T_0}$

The $\rho \sim T$ behavior can be described by a power law of the form:

$$\rho = \rho_0 \left[\frac{T}{T_0} \right]^n$$

In real conditions, only **some metals** follow this relation in **certain temperature range**!



$$\rho = \rho_0 \left[\frac{T}{T_0} \right]^n$$

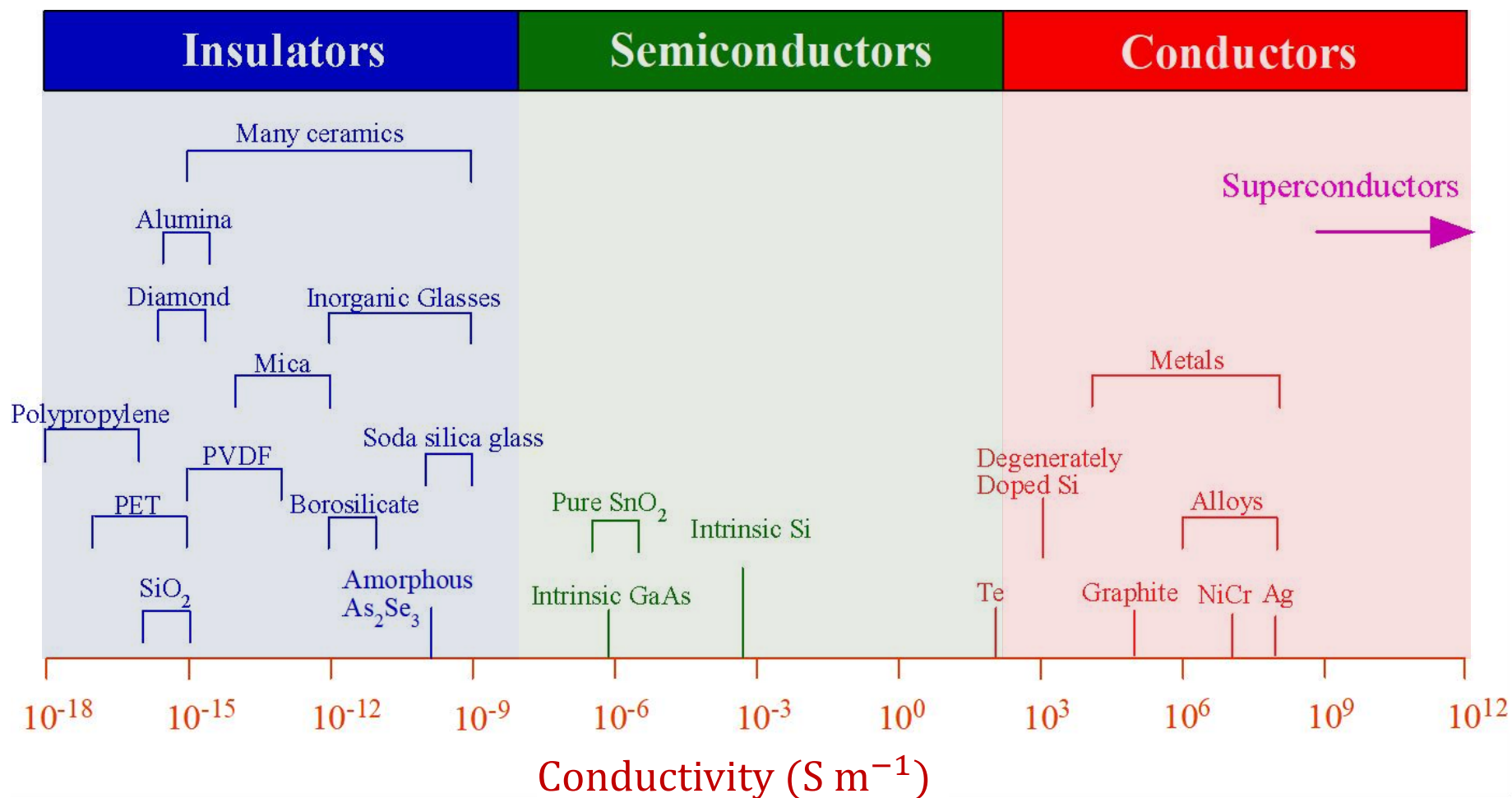
Q: the TCR α_0 ?

$$\alpha_0 = \frac{1}{\rho_0} \left[\frac{\delta \rho}{\delta T} \right]_{T=T_0}$$

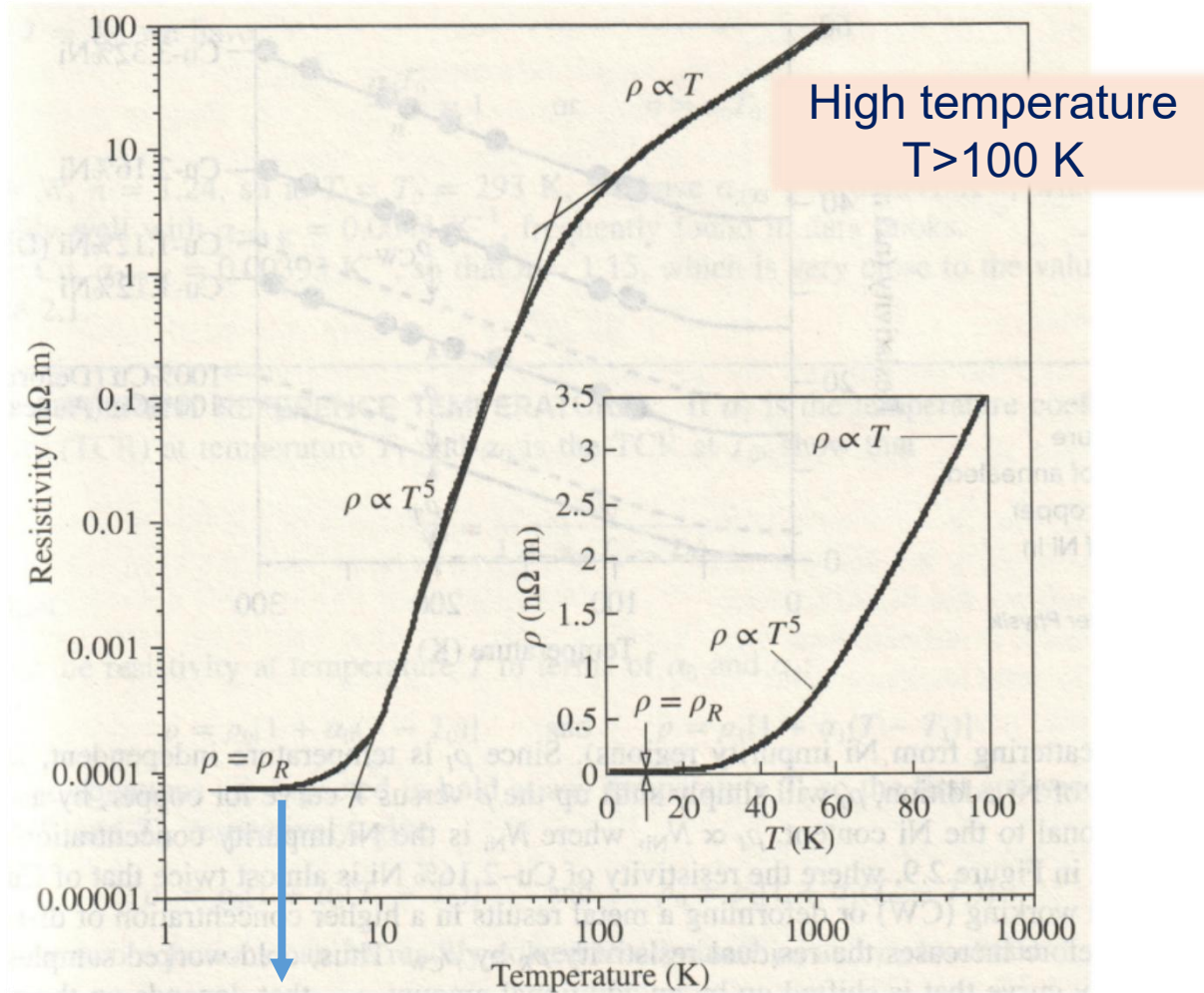


$$\alpha_0 = \frac{n}{T_0}$$

Metal Properties at 273 K					
Metal	273 K	ρ_0 (nΩ · m)	α_0 at 273 K(1/K)	n	T range (K)
Aluminum, Al		24.2	1/227	1.20	200-800
Antimony, Sb		390	1/215	1.27	80-400
Copper, Cu		15.4	1/233	1.16	200-1100
Gold, Au		20.5	1/242	1.13	225-1000
Indium, In		80	1/208	1.31	200-400
Molybdenum, Mo		48.5	1/226	1.21	200-2400
Platinum, Pt		98.1	1/256	1.01	200-1273
Silver, Ag		14.7	1/242	1.13	200-1100
Strontium, Sr, 锶		123	1/276	0.99	273-800
Tin, Sn		115	1/248	1.10	200-490
Tungsten, W		48.2	1/210	1.24	200-3000
Iron, Fe (Magnetic)		85.7	1/159	1.73	200-900
Nickel, Ni (Magnetic)		61.6	1/155	1.76	200-700



Resistivity at low temperature (Copper)



Impurity-scattering-limited resistivity

2.4 Solid solution 固溶体 and Nordheim's rule

Solid solution: an isomorphous alloy of metals, that is, a alloy.

Q: The TCR and resistivity in a binary alloy is higher or lower compared with pure metal?

Matthiessen's rule: $\rho = \rho_T + \rho_R$

The impurity concentration increases with the concentration of solute atoms.



The temperature-independent term ρ_R increases.



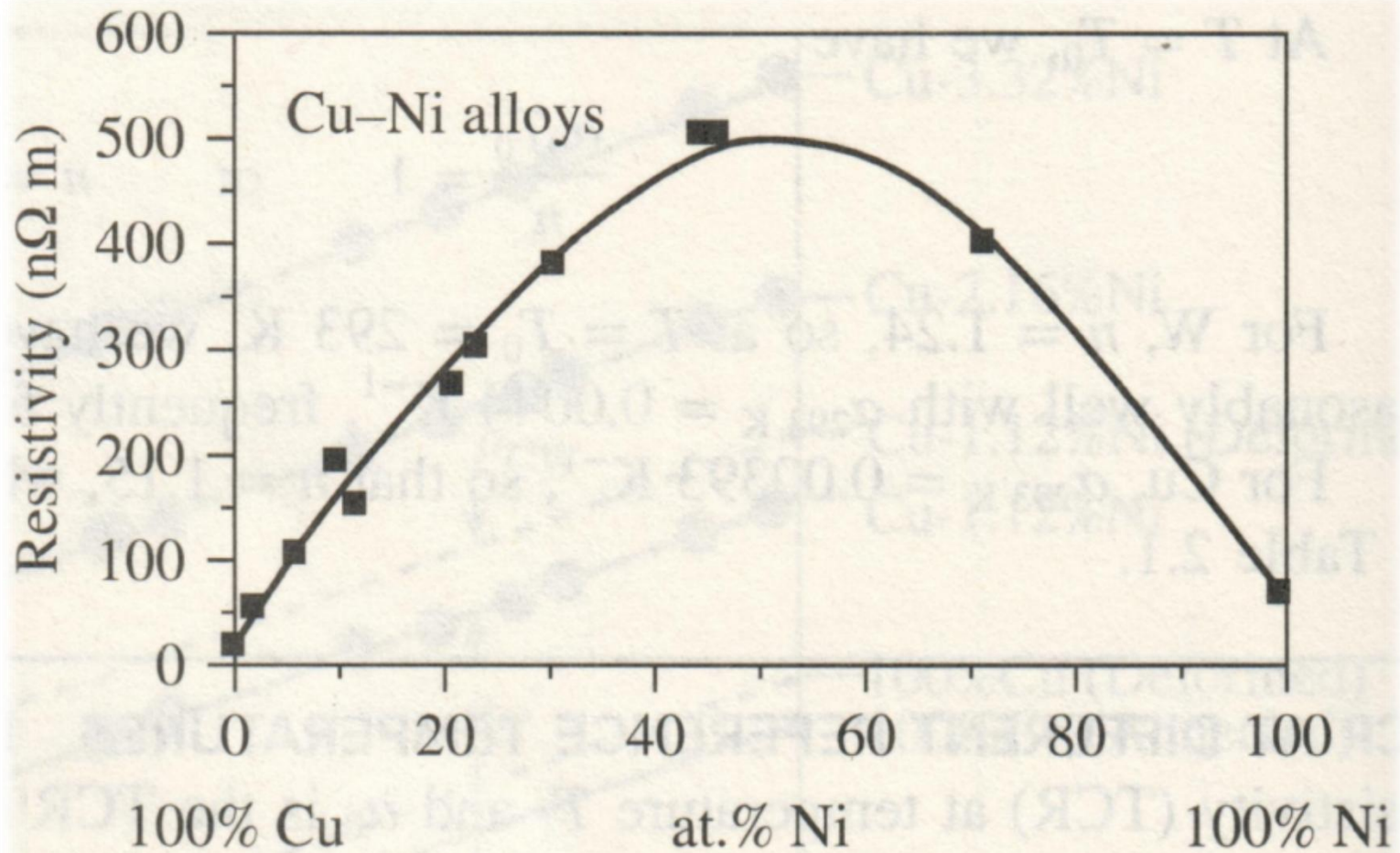
The total resistivity ρ increases and is less sensitive to temperature.

Metal	ρ_0 at 293 K (n $\Omega \cdot$ m)	α_0 at 293 K (1/K)
Nickel	69	1/156
Chrome	129	1/333
Nichrome (80% Ni-20% Cr)	1100	1/2500



Resistivity is less sensitive to temperature

Cu and Ni are both FCC crystals.



Nordheim's rule: an important semiempirical equation to predict the resistivity of an alloy.

The impurity resistivity to the atomic fraction X of solute atoms in a solid solution:

$$\rho_I = CX(1 - X)$$

X : **atomic fraction of solute atoms.**

C : a constant termed the **Nordheim coefficient.**

C represents the effectiveness of the solute atom in increasing the resistivity.

The resistivity of an alloy of composition X is:

$$\rho = \rho_{\text{matrix}} + CX(1 - X)$$

Where $\rho_{\text{matrix}} = \rho_{\text{T}} + \rho_{\text{R}}$ is the resistivity of the matrix due to scattering from thermal vibrations and from other defects

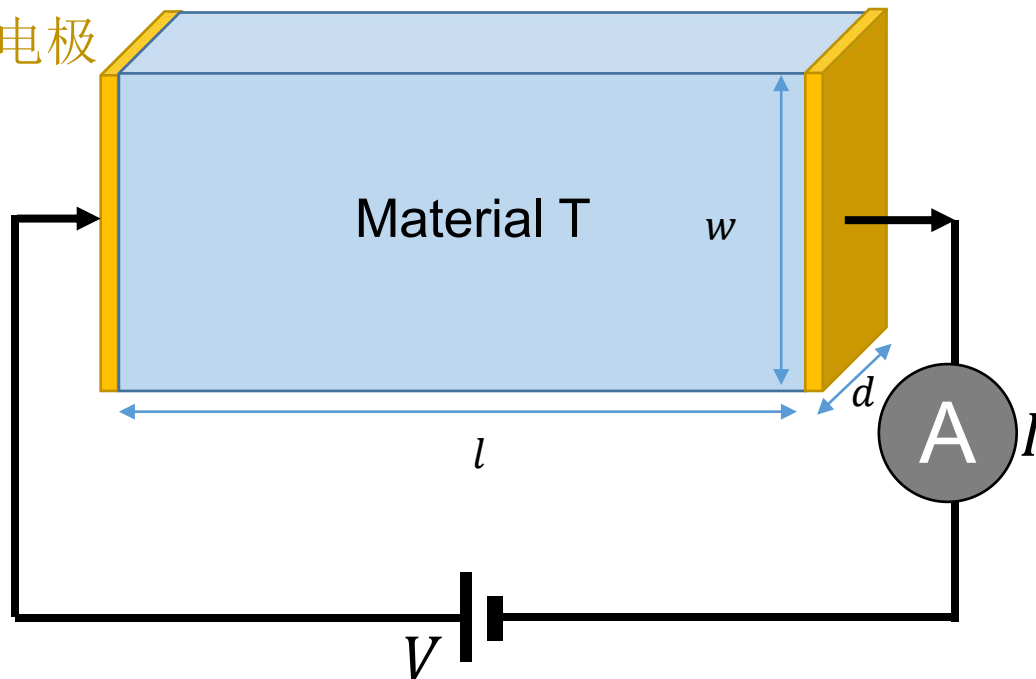
Table: Nordheim coefficient C (at 20 °C) for **dilute alloys**

Solute in Solvent (element in matrix)	C (nΩ m)	Maximum Solubility at 25 °C (at.%)
<u>Au in Cu matrix</u>	5500	100
Mn in Cu matrix	2900	24
Ni in Cu matrix	1200	100
Sn in Cu matrix	2900	0.6
Zn in Cu matrix	300	30
<u>Cu in Au matrix</u>	450	100
Mn in Au matrix	2410	25
Ni in Au matrix	790	100
Sn in Au matrix	3360	5
Zn in Au matrix	950	15

2.5 How to measure resistivity?

Two-terminal measurement

Electrode
电极



Resistance: $R = \frac{V}{I}$

Resistivity: $\rho = R \frac{wd}{l}$

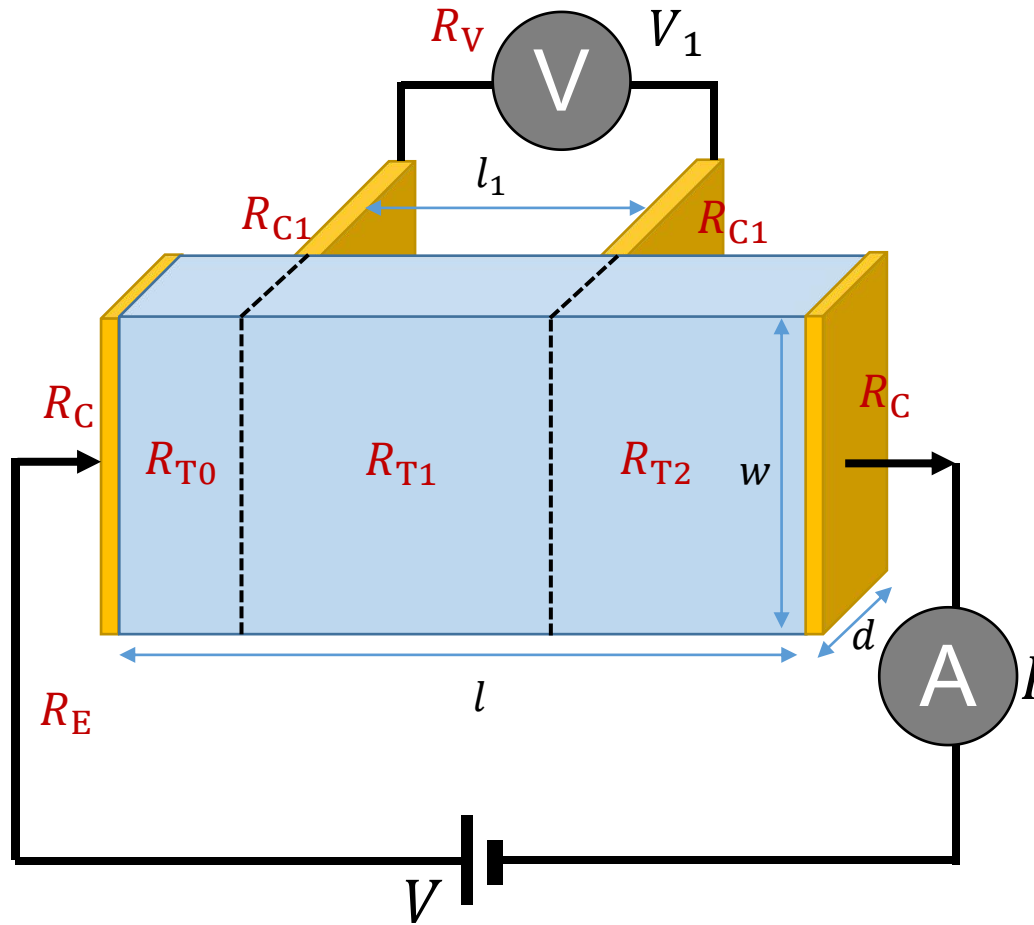
Q: If this measurement is accurate, what condition should be satisfied?

$$R = R_T + 2R_C + R_E$$

R_C : Contact resistance between electrode and material

R_E : Resistance of electrode and wires

Four-terminal measurement



R_V : Resistance of voltage meter
电压表内阻

$$R_V \gg R_E, R_T \text{ and } R_{C1}$$

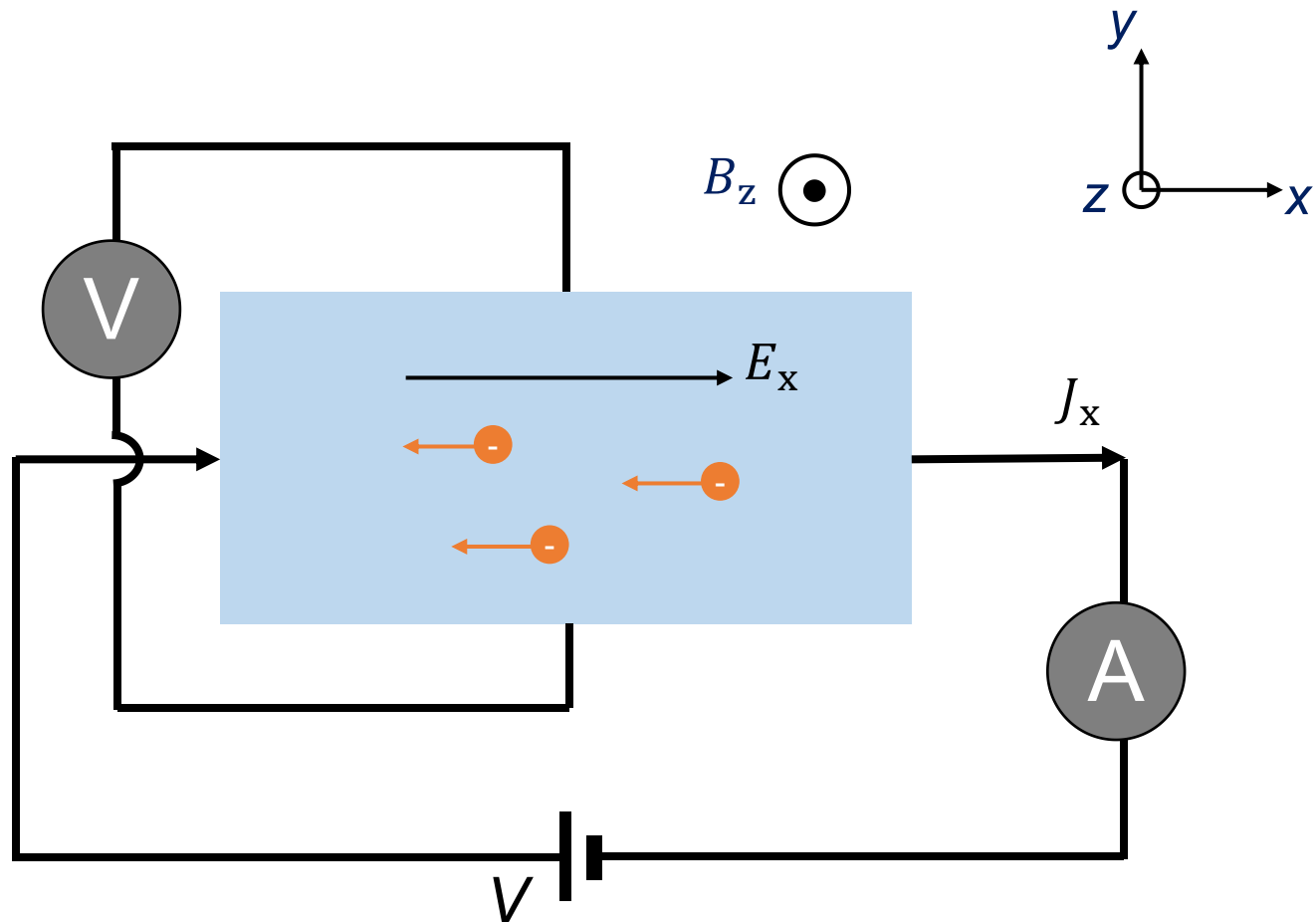
Q: What's the accurate value of R_T ?

$$V = I \times (R_T + 2R_C + R_E)$$

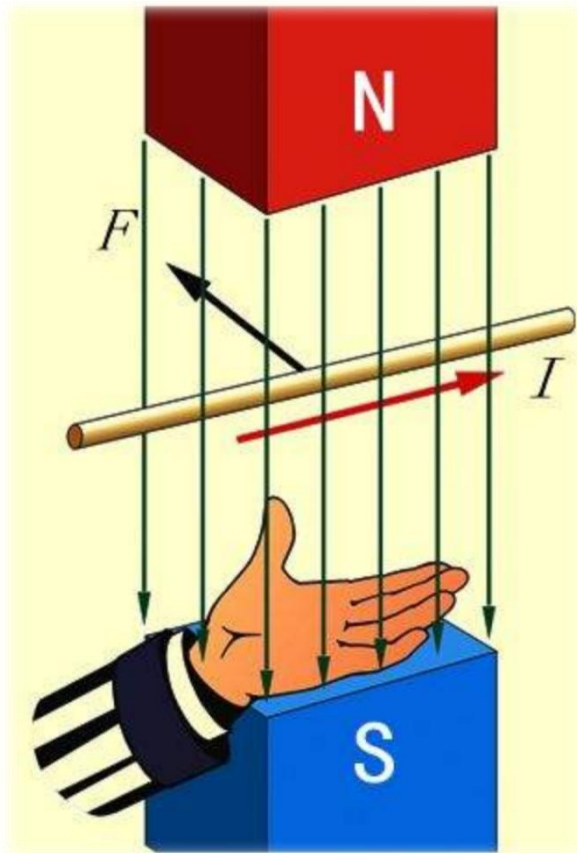
$$V_1 = I \times R_{T1}$$

$$\rho = R_{T1} \frac{wd}{l_1} = \frac{V_1}{I} \frac{wd}{l_1}$$

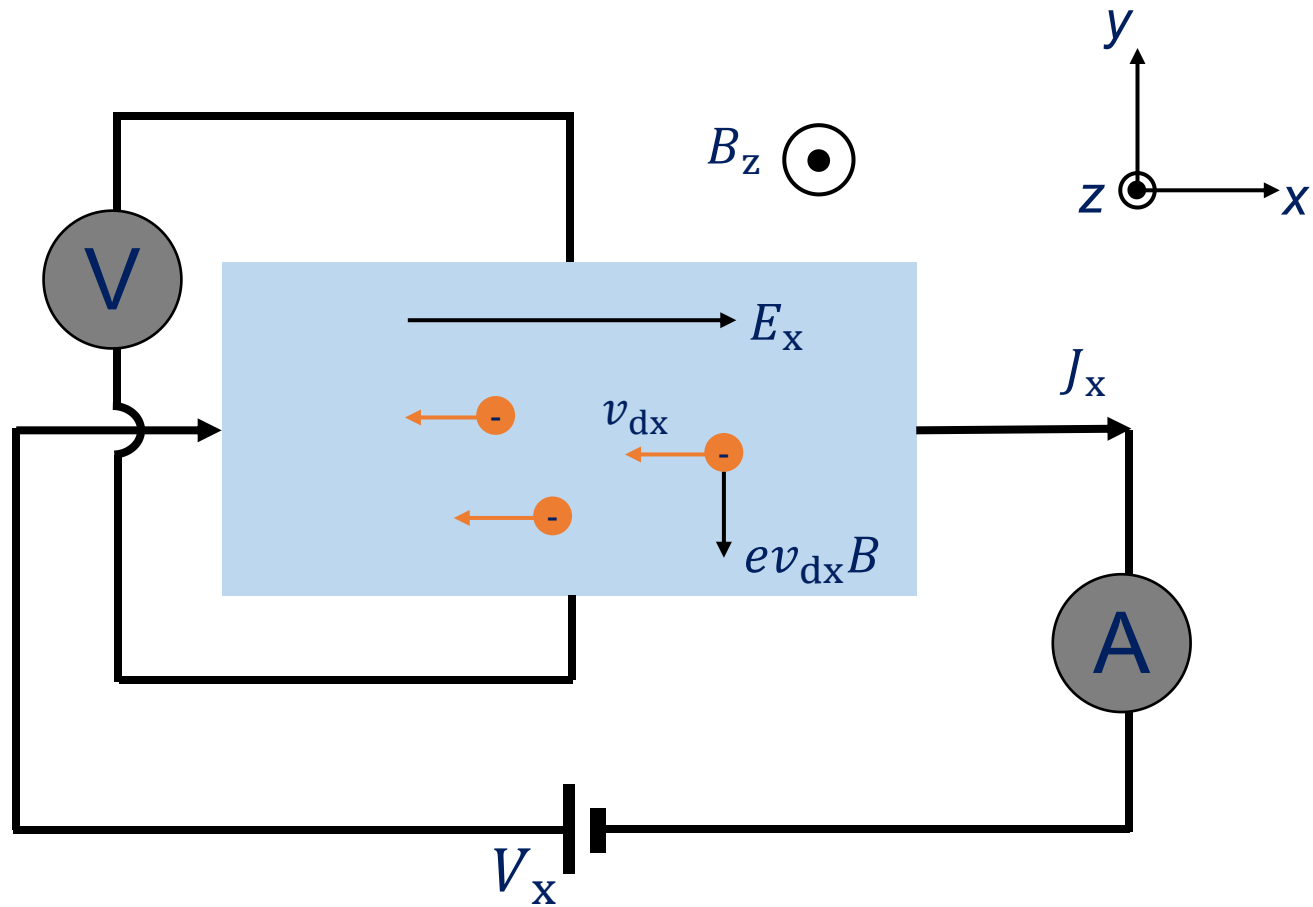
2.6 The Hall effect and Hall devices



Q: The direction of Lorentz force?

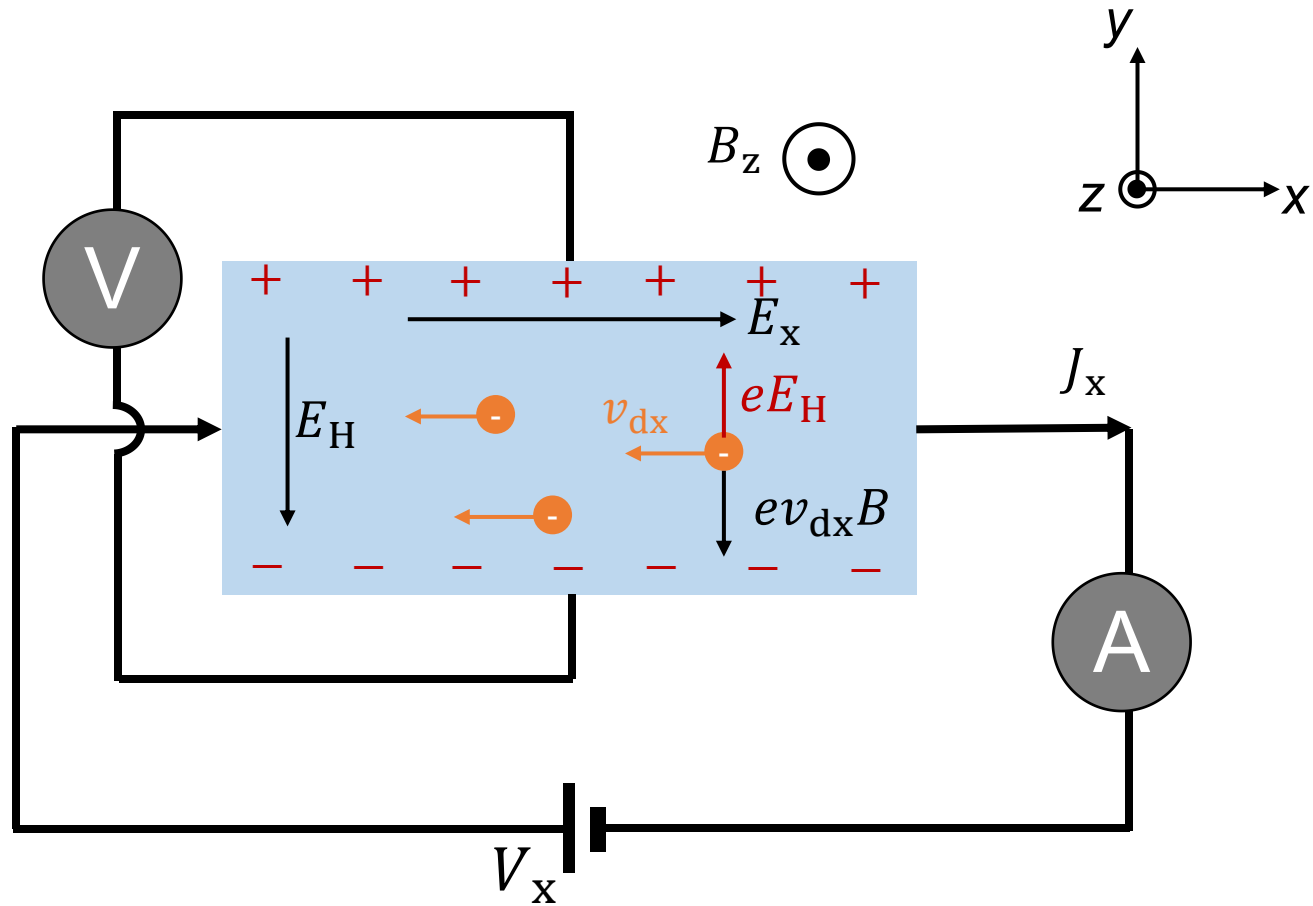


The direction of Lorentz force:
Left-hand rule 左手定则



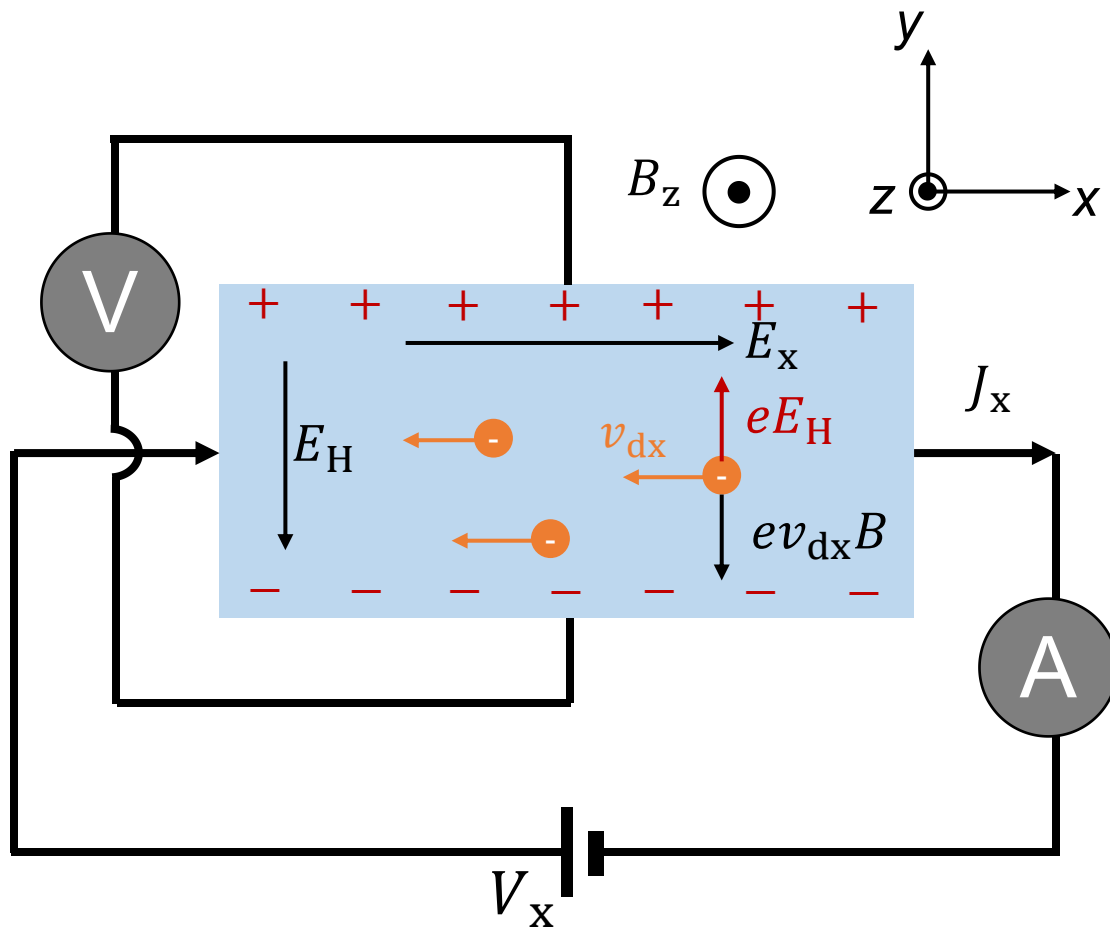
Lorentz force $\vec{F} = q\vec{v} \times \vec{B}$

$$F_y = - e v_{dx} B_z$$



In the steady state: $ev_{dx}B_z = eE_H$

E_H is called the **Hall field**.



$$\begin{cases} E_H = v_{dx} B_z \\ J_x = en v_{dx} \end{cases}$$

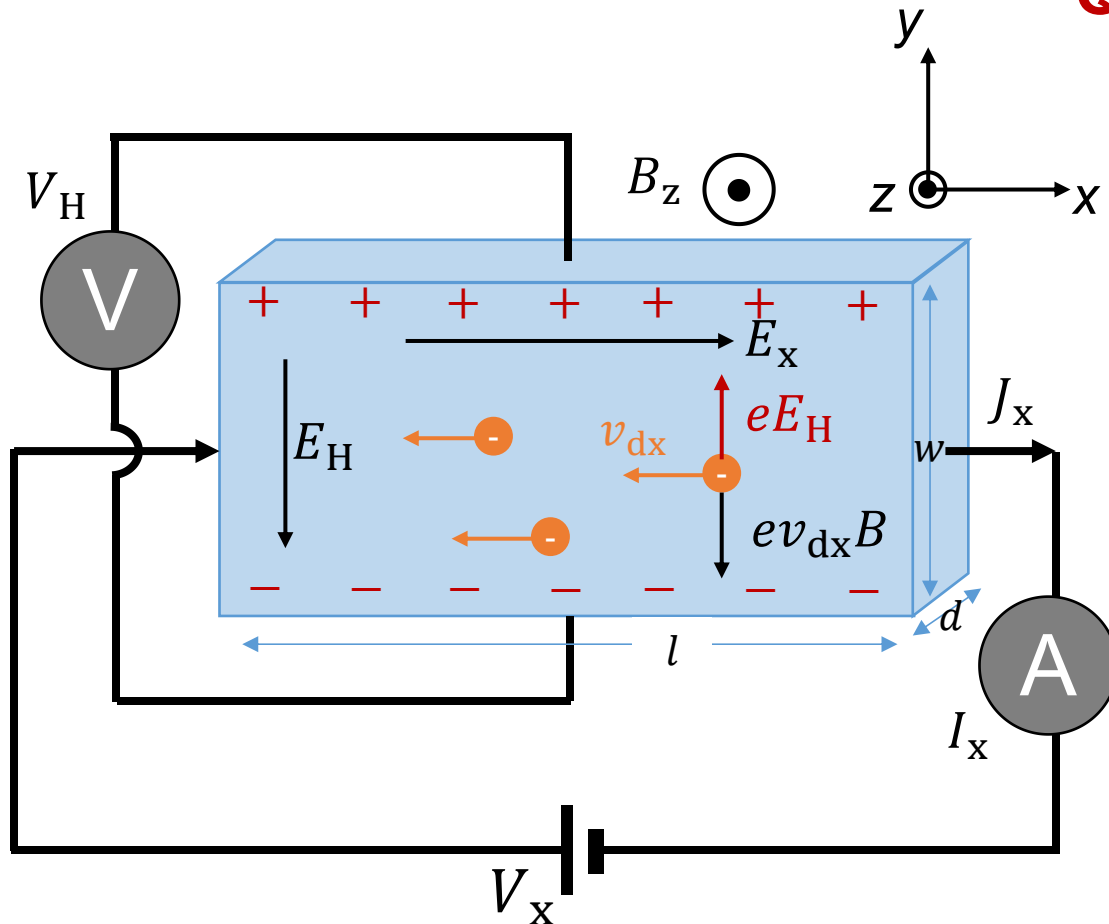


$$E_H = \frac{J_x}{en} B_z$$

Introduce **Hall coefficient: R_H**

$$R_H = -\frac{E_H}{J_x B_z} = -\frac{1}{ne}$$

Q: What we can get from Hall measurement?

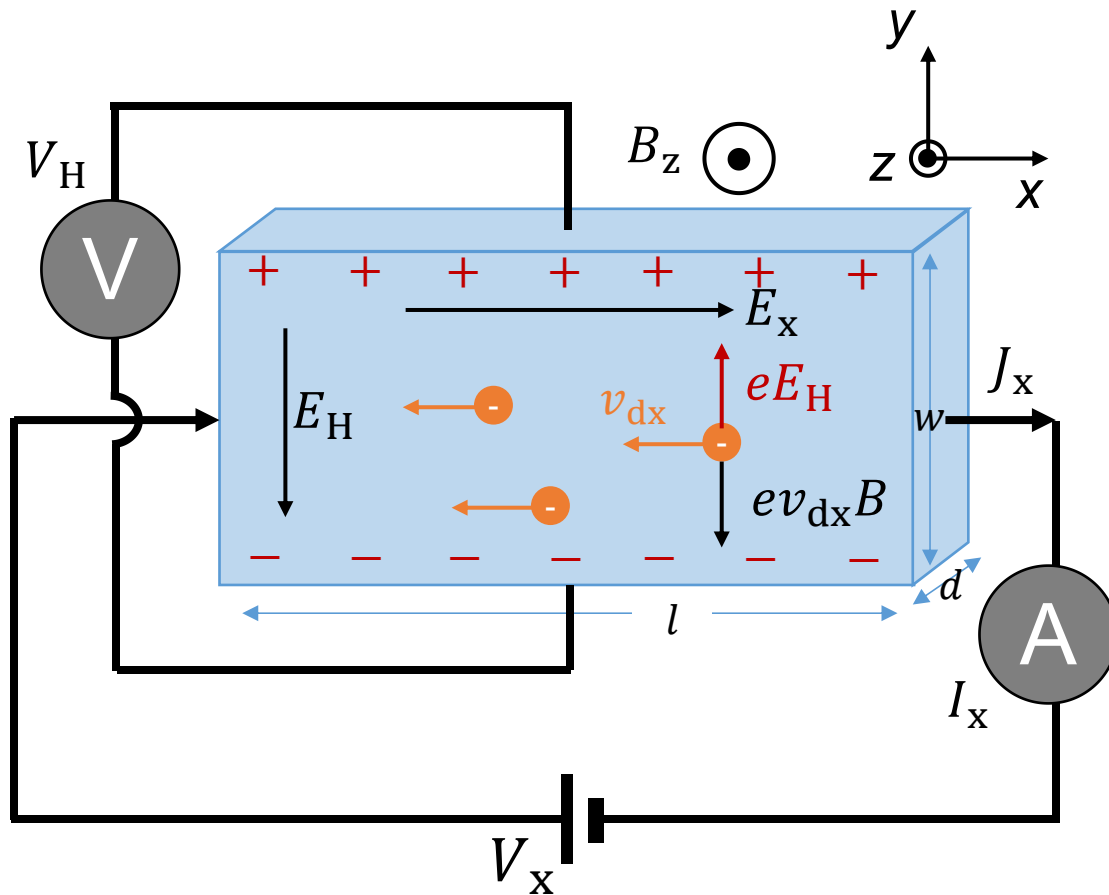


$$\left\{ \begin{aligned} E_H &= \frac{J_x}{en} B_z \\ E_H &= \frac{V_H}{w} \\ J_x &= \frac{I_x}{wd} \end{aligned} \right.$$



$$n = \frac{I_x B_z}{V_H d e}$$

$$R_H = - \frac{V_H d}{I_x B_z}$$



$$\mu_d = \frac{\sigma}{ne} = -R_H \sigma$$

The product σ of and $-R_H$ is called the **Hall mobility**.

$$\sigma = \frac{J_x}{E_x} = \frac{I_x/wd}{V_x/l} = \frac{I_x l}{V_x w d}$$



$$\mu_d = \frac{V_H l}{V_x B_z w}$$



$$\tau = \frac{m_e \mu_d}{e}$$

Hall coefficient and Hall mobility of selected metals at room temperature

Metal	Valency	R_H ($\text{m}^3 \text{A}^{-1} \text{s}^{-1}$) (Experiment) $\times 10^{-11}$	R_H ($\text{m}^3 \text{A}^{-1} \text{s}^{-1}$) (Theory) $\times 10^{-11}$	$\mu_H = \sigma R_H $ ($\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$)
Na	1	-24.8	-24.6	50.8
K	1	-42.8	-47.0	57.9
Ag	1	-9.0	-10.7	53.9
Cu	1	-5.4	-7.4	31.6
Au	1	-7.2	-10.6	31.9
Mg	2	-8.3	-7.2	18.5
Al	3	-3.4	-3.5	12.6

Hall measurement is an effective method to obtain mobility, carrier density and mean scattering time